IPC ASSOCIATION ELECTRONIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				s Materi	rials and Mfg Information					
Supplie	r Information														
Company	name*	Company unique ID			ι	Unique ID Authority					Response Date*				
nsemi												2024-04-17			
Contact Name			Title - Contact			]	Phone - Contact*					Email - Contact*			
Product-	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Dat	e Version	Manufacturing Site  CPA		W	eight*	UOM	Unit Type		
		FFPF085	FFPF08S60SNTU ST2R TO		R TO220F2L PN 8A 600V		2024-04-17			2084.4		mg	Each		
Ianufa	acturing Process Informa	ation													
	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-		-STD-020 MSL	Rating	Peak Process Body Temperatur				Temperatur	e Numb	er of Reflow Cyc	eles	
	Matte Tin (Sn) - annealed		CU Alloy NA			0 C 3			30 seconds			3			
omments	S														
or more	information regarding materia	l composition	please refer to	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (100 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to su											
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		'Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	astislav Drska	-6_									

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	13.9	mg	Supplier	Silicon (Si)	7440-21-3		13.9	mg
Die Attach	7.37		Supplier	Silver (Ag)	7440-22-4		0.1474	mg
			A	Lead (Pb)	7439-92-1	7a	6.4856	mg
			Supplier	Tin (Sn)	7440-31-5		0.737	mg
Lead Frame	1153.73		Supplier	Silver (Ag)	7440-22-4		2.24	mg
			Supplier	Iron (Fe)	7439-89-6		1.15	mg
			Supplier	Copper (Cu)	7440-50-8		1149.9954	mg
			Supplier	Phosphorus (P)	7723-14-0		0.3446	mg
Mold Compound-Black	880.0		Supplier	Ortho Cresol Novolac Resin	29690-82-2		88	mg
			Supplier	Carbon Black (C)	1333-86-4		8.8	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		695.2	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		88	mg
Plating	26.4	mg	Supplier	Tin (Sn)	7440-31-5		26.4	mg
Wire Bond - Al	3.0	mg	Supplier	Aluminum (Al)	7429-90-5		3	mg